1. General description

The 74HC109; 74HCT109 is a dual positive edge triggered $J\overline{K}$ flip-flop featuring individual J and \overline{K} inputs, clock (CP) inputs, set ($\overline{S}D$) and reset ($\overline{R}D$) inputs and complementary Q and \overline{Q} outputs. The set and reset are asynchronous active LOW inputs and operate independently of the clock input. The J and \overline{K} inputs control the state changes of the flip-flops as described in the mode select function table. The J and \overline{K} inputs must be stable one set-up time prior to the LOW-to-HIGH clock transition for predictable operation. The J \overline{K} design allows operation as a D-type flip-flop by connecting the J and \overline{K} inputs together. This device features reduced input threshold levels to allow interfacing to TTL logic levels. Inputs also include clamp diodes, this enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

Schmitt-trigger action in the clock input makes the circuit highly tolerant to slower clock rise and fall times.

2. Features and benefits

- J and K inputs for easy D-type flip-flop
- · Toggle flip-flop or "do nothing" mode
- Wide supply voltage range:
 - For 74HC109: from 2.0 V to 6.0 V
 - For 74HCT109: from 4.5 V to 5.5 V
- CMOS low power dissipation
- High noise immunity
- Input levels:
 - For 74HC109: CMOS level
 - For 74HCT109: TTL level
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- 74HC109 complies with JEDEC standards:
 - JESD8C (2.7 V to 3.6 V)
 - JESD7A (2.0 V to 6.0 V)
- 74HCT109 complies with JEDEC standard JESD7A (2.0 V to 6.0 V)
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

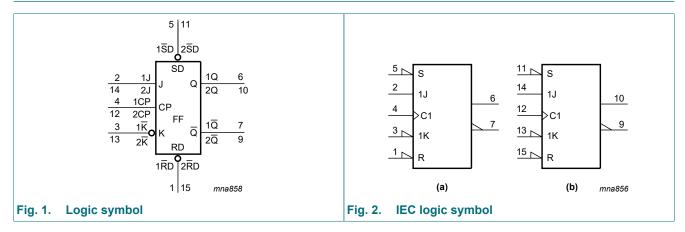
3. Ordering information

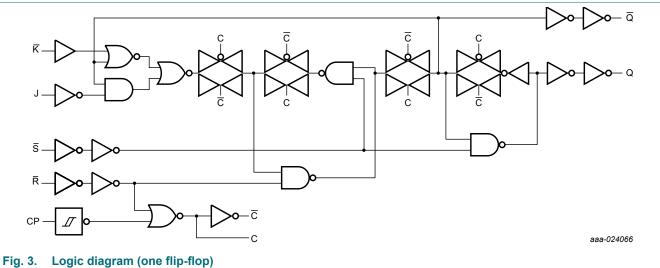
Table 1. Ordering information

Type number	Package	Package										
	Temperature range	Name	Description	Version								
74HC109D 74HCT109D	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1								
74HC109PW 74HCT109PW	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1								



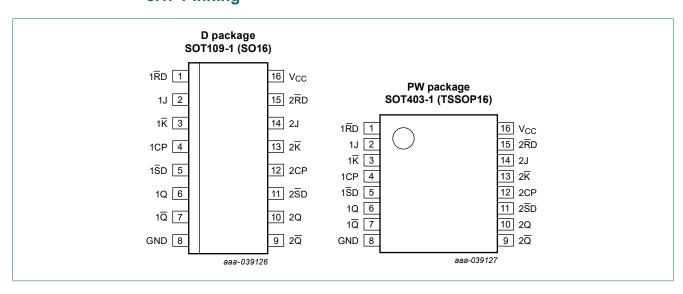
4. Functional diagram





5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1RD, 2RD	1, 15	asynchronous reset input (active LOW)
1J, 2J	2, 14	synchronous input
1K, 2K	3, 13	synchronous input
1CP, 2CP	4, 12	clock input (LOW-to-HIGH; edge-triggered)
1 S D, 2 S D	5, 11	asynchronous set input (active LOW)
1Q, 2Q	6, 10	true flip-flop output
1Q, 2Q	7, 9	complement flip-flop output
GND	8	ground (0 V)
V _{CC}	16	supply voltage

6. Functional description

Table 3. Function selection

H = HIGH voltage level; h = HIGH voltage level one set-up time before the LOW-to-HIGH CP transition;

L = LOW voltage level; I = LOW voltage level one set-up time before the LOW-to-HIGH CP transition;

q = lower case letters indicate the state of the referenced output one set-up time before the LOW-to-HIGH CP transition;

 $X = don't care; \uparrow = LOW-to-HIGH CP transition$

Operating modes	Input		Output	Output			
	nSD	nRD	nCP	nJ	nK	nQ	nQ
Asynchronous set	L	Н	Х	Х	Х	Н	L
Asynchronous reset	Н	L	X	Х	Х	L	Н
Undetermined	L	L	X	Х	Х	Н	Н
Toggle	Н	Н	1	h	I	q	q
Load 0 (reset)	Н	Н	1	I	I	L	Н
Load 1 (set)	Н	Н	1	h	h	Н	L
Hold no change	Н	Н	1	I	h	q	q

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+7	V
I _{IK}	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$	-	±20	mA
I _{OK}	output clamping current	$V_{O} < -0.5 \text{ V or } V_{O} > V_{CC} + 0.5 \text{ V}$	-	±20	mA
Io	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$	-	±25	mA
I _{CC}	supply current		-	+50	mA
I_{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	[1]	-	500	mW

^[1] For SOT109-1 (SO16) package: P_{tot} derates linearly with 12.4 mW/K above 110 °C. For SOT403-1 (TSSOP16) package: P_{tot} derates linearly with 8.5 mW/K above 91 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74HC109			74HCT10	9	Unit	
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 2.0 V	-	-	625	-	-	-	ns/V
		V _{CC} = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V _{CC} = 6.0 V	-	-	83	-	-	-	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C			°C to 5 °C		°C to 5 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	1
74HC10	9									
V _{IH}	HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V _{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL}								
	output voltage	I _O = -20 μA; V _{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I _O = -20 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -20 μA; V _{CC} = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		$I_O = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	3.84	-	3.7	-	V
		$I_O = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL}								
	output voltage	$I_O = 20 \mu A; V_{CC} = 2.0 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 6.0 V$	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA; V _{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I_{O} = 5.2 mA; V_{CC} = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
I _I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1	-	±1	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	4.0	-	40	-	80	μΑ
C _I	input capacitance		-	3.5	-	-	-	-	-	pF

Symbol	Parameter	Conditions		25 °C			°C to 5 °C		°C to 5 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HCT1	09									
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -4.0 mA	3.98	4.32	-	3.84	-	3.7	-	V
V_{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = 20 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 5.2 mA; V _{CC} = 5.5 V	-	0.15	0.26	-	0.33	-	0.4	V
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	-	±1	-	±1	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	4.0	-	40	-	80	μA
Δl _{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V}$; other inputs at V_{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V								
		nJ, nK, nSD, nRD and nCP inputs	-	35	126	-	157.5	-	171.5	μA
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit, see Fig. 6.

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
74HC10	9									'
t _{pd}	propagation	nCP to nQ, $n\overline{Q}$; see $\underline{\text{Fig. 4}}$ [2]								
	delay	V _{CC} = 2.0 V	-	50	175	-	220	-	265	ns
		V _{CC} = 4.5 V	-	18	35	-	44	-	53	ns
		V _{CC} = 5 V; C _L = 15 pF	-	15	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	14	30	-	37	-	45	ns
t _{PLH}		nSD to nQ, see Fig. 5								
	propagation delay	V _{CC} = 2.0 V	-	30	120	-	150	-	180	ns
	delay	V _{CC} = 4.5 V	-	11	24	-	30	-	36	ns
		V _{CC} = 5 V; C _L = 15 pF	-	12	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	9	20	-	26	-	31	ns

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	Min	Max	
t _{PHL}		nSD to nQ; see Fig. 5								
	propagation delay	V _{CC} = 2.0 V	-	41	155	-	195	-	235	ns
	uelay	V _{CC} = 4.5 V	-	15	31	-	39	-	47	ns
		V _{CC} = 5 V; C _L = 15 pF	-	12	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	12	26	-	33	-	40	ns
t _{PHL}	HIGH to LOW	nRD to nQ; see Fig. 5								
	propagation delay	V _{CC} = 2.0 V	-	41	185	-	230	-	280	ns
	uelay	V _{CC} = 4.5 V	-	15	37	-	46	-	56	ns
		V _{CC} = 5 V; C _L = 15 pF	-	12	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	12	31	-	39	-	48	ns
t _{PLH}		nRD to nQ; see Fig. 5								
	propagation	V _{CC} = 2.0 V	-	39	170	-	215	-	255	ns
	delay	V _{CC} = 4.5 V	-	14	34	-	43	-	51	ns
		V _{CC} = 5 V; C _L = 15 pF	-	12	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	11	29	-	37	-	43	ns
t _t	transition time	$nQ, n\overline{Q}; see \underline{Fig. 4}$ [3]								
		V _{CC} = 2.0 V	-	19	75	-	95	-	110	ns
		V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
		V _{CC} = 6.0 V	-	6	13	-	16	-	19	ns
t _W	pulse width	nCP HIGH or LOW; see Fig. 4								
		V _{CC} = 2.0 V	80	19	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	7	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	6	-	17	-	20	-	ns
		nSD, nRD HIGH or LOW; see Fig. 5								
		V _{CC} = 2.0 V	80	14	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	5	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	4	-	17	-	20	-	ns
t _{rec}	recovery time	nSD, nRD to nCP; see Fig. 5								
		V _{CC} = 2.0 V	70	19	-	90	-	105	-	ns
		V _{CC} = 4.5 V	14	7	-	18	-	21	-	ns
		V _{CC} = 6.0 V	12	6	-	15	-	18	-	ns

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C t	o +125 °C	Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
t _{su}	set-up time	nJ and nK to nCP; see Fig. 4								
		V _{CC} = 2.0 V	70	17	-	90	-	105	-	ns
		V _{CC} = 4.5 V	14	6	-	18	-	21	-	ns
		V _{CC} = 6.0 V	12	5	-	15	-	18	-	ns
t _h	hold time	nJ and nK to nCP; see Fig. 4								
		V _{CC} = 2.0 V	5	0	-	5	-	5	-	ns
		V _{CC} = 4.5 V	5	0	-	5	-	5	-	ns
		V _{CC} = 6.0 V	5	0	-	5	-	5	-	ns
f _{max}	maximum	nCP; see Fig. 4								
	frequency	V _{CC} = 2.0 V	6	22	-	5	-	4	-	MHz
		V _{CC} = 4.5 V	30	68	-	24	-	20	-	MHz
		V _{CC} = 5 V; C _L = 15 pF	-	75	-	-	-	-	-	MHz
		V _{CC} = 6.0 V	35	81	-	28	-	24	-	MHz
C _{PD}	power dissipation capacitance	C_L = 50 pF; f = 1 MHz; [4] V _I = GND to V _{CC}	-	20	-	-	-	-	-	pF
74HCT1	09			'	l		1			'
t _{pd}	propagation	nCP to nQ, nQ;see Fig. 4 [2]								
	delay	V _{CC} = 4.5 V	-	20	35	-	44	-	53	ns
		V _{CC} = 5 V; C _L = 15 pF	-	17	-	-		-	-	ns
t _{PLH}	LOW to HIGH	nSD to nQ, see Fig. 5								
	propagation delay	V _{CC} = 4.5 V	-	13	26	-	33	-	39	ns
	delay	V _{CC} = 5 V; C _L = 15 pF	-	14	-	-	-	-	-	ns
t _{PHL}	HIGH to LOW	$n\overline{S}D$ to $n\overline{Q}$; see <u>Fig. 5</u>								
	propagation delay	V _{CC} = 4.5 V	-	19	35	-	44	-	53	ns
	delay	V _{CC} = 5 V; C _L = 15 pF	-	14	-	-	-	-	-	ns
t _{PHL}	HIGH to LOW	nRD to nQ; see Fig. 5								
	propagation delay	V _{CC} = 4.5 V	-	19	35	-	44	-	53	ns
	delay	V _{CC} = 5 V; C _L = 15 pF	-	15	-	-	-	-	-	ns
t _{PLH}		nRD to nQ; see Fig. 5								
	propagation	V _{CC} = 4.5 V	-	16	32	-	40	-	48	ns
	delay	V _{CC} = 5 V; C _L = 15 pF	-	15	-	-	-	-	-	ns
t _t	transition time	nQ, \overline{NQ} ; $V_{CC} = 4.5 \text{ V}$; [3] see Fig. 4	-	7	15	-	19	-	22	ns
t _W	pulse width	nCP HIGH or LOW; V _{CC} = 4.5 V; see <u>Fig. 4</u>	18	9	-	23	-	27	-	ns
		\overline{NSD} , \overline{NRD} HIGH or LOW; $V_{CC} = 4.5 \text{ V}$; see Fig. 5	16	8	-	20	-	24	-	ns
t _{rec}	recovery time	$n\overline{S}D$, $n\overline{R}D$ to nCP ; $V_{CC} = 4.5 \text{ V}$; see Fig. 5	16	8	-	20	-	24	-	ns

Symbol	Parameter	Conditions		25 °C		-40 °C to	+85 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
t _{su}	set-up time	nJ and n \overline{K} to nCP; V _{CC} = 4.5 V; see Fig. 4	18	8	-	23	-	27	-	ns
t _h	hold time	nJ and n \overline{K} to nCP; V _{CC} = 4.5 V; see Fig. 4	3	-3	-	3	-	3	-	ns
f _{max}	maximum	nCP; see Fig. 4								
	frequency	V _{CC} = 4.5 V	27	55	-	22	-	18	-	MHz
		V _{CC} = 5 V; C _L = 15 pF	-	61	-	-	-	-	-	MHz
C _{PD}	power dissipation capacitance	$C_L = 50 \text{ pF; } f = 1 \text{ MHz;}$ [4] $V_I = \text{GND to } V_{CC} - 1.5 \text{ V}$	-	22	-	-	-	-	-	pF

- [1] All typical values are measured at T_{amb} = 25 °C.
- [2] t_{pd} is the same as t_{PLH} and t_{PHL} .
- [3] t_t is the same as t_{THL} and t_{TLH} .
- [4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$$
 where:

 f_i = input frequency in MHz;

f_o = output frequency in MHz;

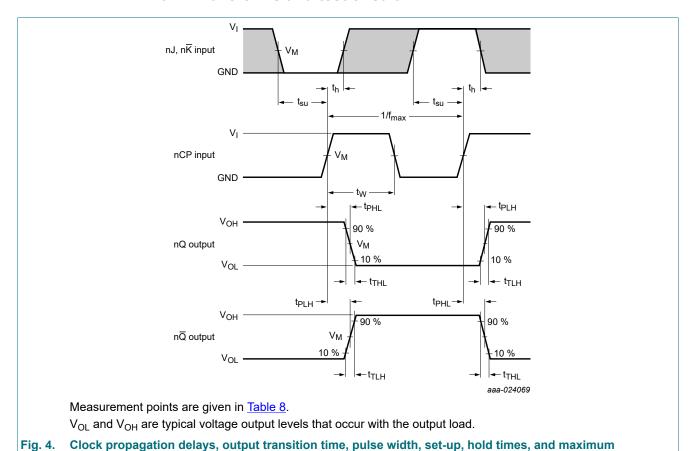
C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_0) = \text{sum of outputs.}$

10.1. Waveforms and test circuit



frequency

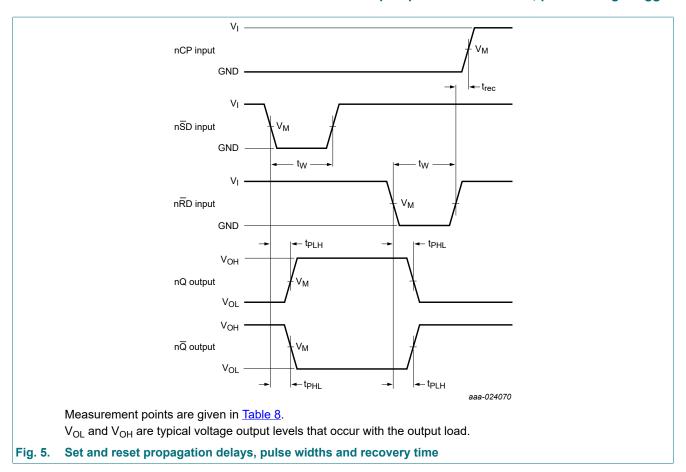
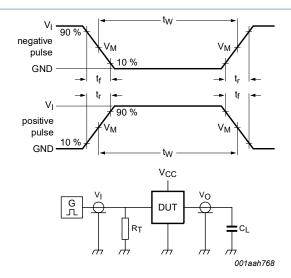


Table 8. Measurement points

Туре	Input	Output
	V _M	V _M
74HC109	0.5 × V _{CC}	0.5 × V _{CC}
74HCT109	1.3 V	1.3 V



Test data is given in Table 9.

Definitions test circuit:

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator;

C_L = Load capacitance including jig and probe capacitance;

 R_L = Load resistance.

Fig. 6. Test circuit for measuring switching times

Table 9. Test data

Туре	Input		Load	Test
	V _I	t _r , t _f	CL	
74HC109	V _{CC}	6 ns	15 pF, 50 pF	t _{PLH} , t _{PHL}
74HCT109	3 V	6 ns	15 pF, 50 pF	t _{PLH} , t _{PHL}

11. Package outline

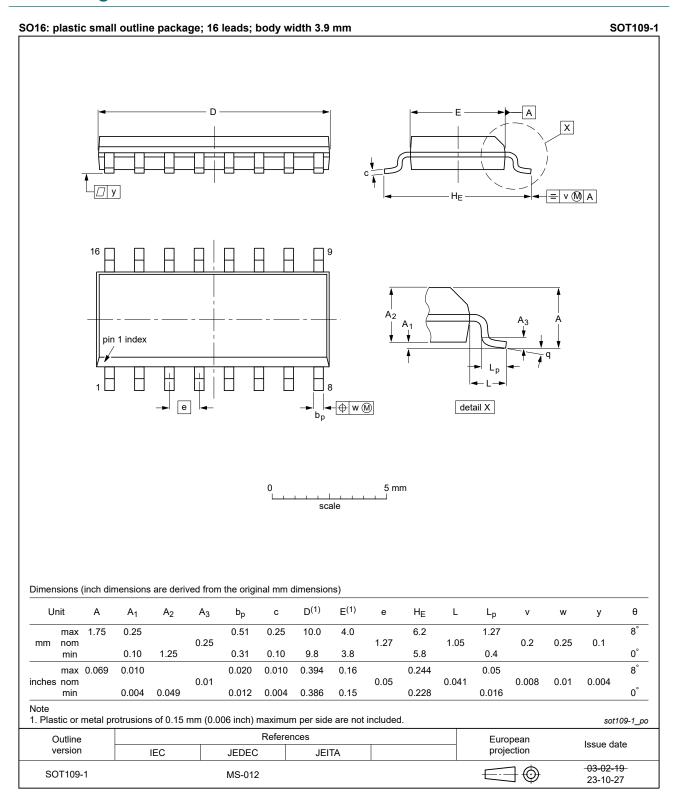


Fig. 7. Package outline SOT109-1 (SO16)

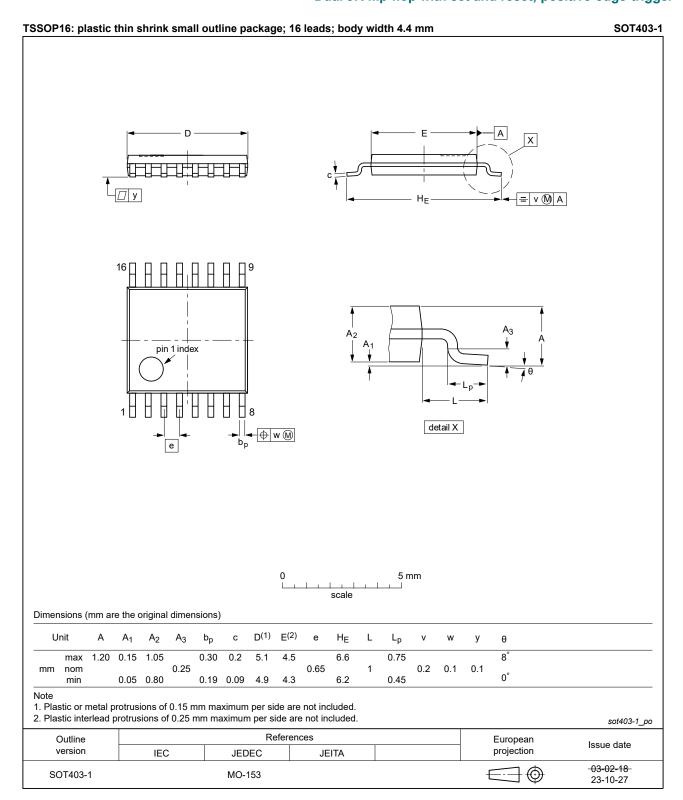


Fig. 8. Package outline SOT403-1 (TSSOP16)

12. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
TTL	Transistor-Transistor Logic

13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74HC_HCT109 v.6	20240221	Product data sheet	-	74HC_HCT109 v.5	
Modifications:	 <u>Section 2</u>: ESD specification updated according to the latest JEDEC standard. <u>Fig. 7</u>, <u>Fig. 8</u>: Aligned SO and TSSOP package outline drawings to JEDEC MS-012 and MO-153 				
74HC_HCT109 v.5	20210805	Product data sheet	-	74HC_HCT109 v.4	
Modifications:	 Type number 74HC109PW (SOT403-1/TSSOP16) added. Type numbers 74HC109DB and 74HCT109DB (SOT338-1/SSOP16) removed. Section 1 and Section 2 updated. 				
74HC_HCT109 v.4	20200401	Product data sheet	-	74HC_HCT109 v.3	
Modifications:	 The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Table 4: Derating values for P_{tot} total power dissipation updated. 				
74HC_HCT109 v.3	20160801	Product data sheet	-	74HC_HCT109_CNV v.2	
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. 				
74HC_HCT109_CNV v.2	19971125	Product specification	-	-	

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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